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Complete if Known

Application Number	09/327 826
Filing Date	June 7, 1999
First Named Inventor	JIAN
Group Art Unit	
Examiner Name	

Attorney Docket Number

2790-P001

06/08/99

OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
hu		CARSON et al., "Future Manufacturing Techniques for Stacked MCM Interconnections", Journal of Metal, June 1994, pp. 51-55.	
hu		KO et al., "Bonding Techniques for Microsensors", Micromachining and Micropackaging of Transducers, Elsevier Science Publisher, Amsterdam, 1996, pp. 41-61.	
hu		LEE et al., "Low Cost High Quality Fabrication Methods and CAD for Diffractive Optics and Computer Holograms Compatible with Micro-Electronics and Micro-Mechanics Fabrication", Diffractive Optics and Optical Microsystems, Plenum Press, New York, 1997, pp. 133-138.	
hu		MATSUDA et al., "A Surface-Emitting Laser Array with Backside Guiding Holes for Passive Alignment to Parallel Optical Fibers", IEEE Photonics Technology Letters, Vol. 8, No. 4, 1996, pp.494-495.	
hu		RAINER et al., "Low Temperature Bonding of Epitaxial Lift Off Devices With AuSn", IEEE Transactions on Components, Packaging, and Manufacturing Technology, Part B, Vol. 19, No. 3. 1996, pp. 575-580.	
hu		REIMER et al., "Micro-Optic Fabrication Using One-Level Gray-Tone Lithography", SPIE Vol. 3008, 1997, pp. 279-288.	
hu		STRZELECKA et al., "Monolithic Integration of Vertical-Cavity Laser Diodes With Refractive GaAs Microlenses", Electronics Letters, Vol. 31, No. 9, 1995, pp. 724-725.	
hu		TAI, "90% Coupling of Top Surface Emitting GaAs/AlGaAs Quantum Well Laser Output Into 8 Micron Diameter Core Silica Fibre", Electronics Letters, Vol. 26, No. 19, 1990, pp. 1628-1629.	
hu		WANG et al., "Robust Regression Applied to Optical-Fiber Dimensional Quality Control", Technometrics, Vol. 39, No. 1, 1997, pp. 95-103.	

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